Classification	REFERENCE SPECIFICATION	Issue No. 20151245
Part Name 3.5mm x 2.9mm SMD	Part No.	1 / 0
Light Touch Switch	EVPAAN02Q	1 / 8

1. Notification Items

1.1 Law and the regulation which are applied

Ozone depleting substances specified by Montreal Protocol have not been used in the manufacturing process of the material used in this product.

This product complies with RoHS Directive (on the restriction of the use of certain hazardous substances in electrical and electronic equipment) (2011/65/EU).

The materials used in this product contain only the substances listed in the List of Existing Chemical Substances specified in 'Act on the Evaluation of Chemical Substances and Regulation of Their Manufacture, etc'.

Permission must be obtained from the Japanese government if the product that is subject to the "Foreign Exchange and Foreign Trade Law" is to be exported or taken out of Japan.

1.2 Application Limits

The following shall be described for safety precaution:

[Limitation of Application]

- This product has been designed and manufactured for general electronic devices, such as home electronics, office equipment, information device and communication devices. In an event that this product is used for more sophisticated applications requiring higher safety and reliability and its failure or malfunction of this product may impose damage to human life or property, agreement on product specifications for approval suitable for such applications are required. Such applications shall include the following:
 - aircraft equipment, aerospace equipment, disaster prevention / crime prevention equipment, medical equipment, transportation equipment (vehicles, trains, ships, etc.), information processing equipment that are highly publicized, and other equivalent equipment
- Regardless of its applications, in an event that this product is used for the equipment requiring high safety levels, place protective circuits or redundant circuits and perform safety tests to improve your products safety.

1.3 Handling of reference specification.

• Since the contents of this reference specification are subjected to change without prior notifications, please request us a formal specification again for your investigations before using.

1.4 Manufacturing Sites

The country of manufacture: China Panasonic Industrial Devices (Qingdao) Co., Ltd.

Panasonic Corporation

2. Summary

2.1 This specifications applies to the following types of switch.

Push-ON type S.P.S.T

- 2.2 This specifications is a constituent document of contract for business concluded between your company and Panasonic Corporation.
- 2.3 Items not particularly specified in this specifications shall be in conformance with JIS Standards.

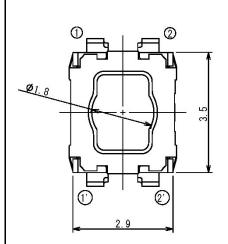
Classification	REFERENCE SPECIFICATION	Issue No. 20151245
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Light Touch Switch	EVPAAN02O	2 / 8

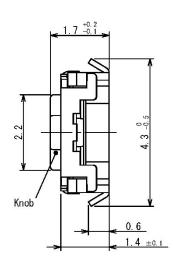
3. Dimension · Marking · Circuit diagram

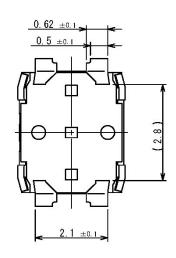
Date code are indicated in the product.

General dimension tolerance: ± 0.2

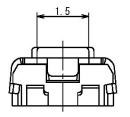
()dimensions are reference dimensions.

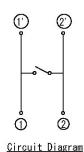






REFERENCE ONLY

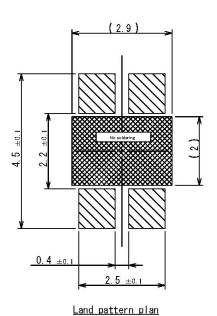




Knob color: GRAY

Piece: about 0.035g

Solder thickness t=0.15±0.03



: Recommended land pattern area >>>>>> : No soldering area

- Any land pattern or via holes shall not be
- provided at *** area.

 If it's necessary to design land pattern or via holes at *** area, please apply resist to them to protect their
- metal part completely.

 If their metal parts are not protected completely, short circuit failure may occur by solder ball.

 Besides, there should be convexoconcave by deciming additional pattern.
- designing additional pattern, it may cause swith tilt, influence on solder-ability or flux intrusion after reflow soldering.

 Therefore, please study any influence of additional land pattern or via holes at
- area in advance.

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4. General specification

4.1 Switch rating DC 15 V 20 mA(max.) DC 2 V 10 μA(min.)

4.2 Operation temperature range $-40 \sim +90$

4.3 Preservative temperature range Single condition : $-40 \sim +90$

Taping conditior: $-20 \sim +60$

4.4 Standard conditions

Unless otherwise specified, the test and measurements shall be carried out as follows.

Ambient temperature : $5 \sim 35$ Relative humidity : $45 \sim 85 \%$ Atmospheric pressure : $86 \sim 106 \text{ kPa}$

However, if doubt arises on the decision based on the measured values

under the above-mentioned conditions, the following conditions shall be employed.

Ambient temperature : 20 ± 2 Relative humidity : $65 \pm 5 \%$ Atmospheric pressure : $86 \sim 106 \text{ kPa}$

5. Performance

5.1 Electrical characteristics

No.	ITEM	TEST CONDITION	PERFORMANCE
5.1.1	Contact	Push force : $\{\text{Operation force}\} \times 2$	100 mΩ max.
	resistance	Measurement tool : Contact resistance meter	
		(Capable of $10 \mu A \sim 10 mA$)	
5.1.2	Insulation	DC 100 V (Between terminals)	100 MΩ min.
	resistance		
5.1.3	Withstand	AC 250 V for 1 minute. (Between terminals)	No insulation
	voltage		destruction
5.1.4	Bouncing	Operation speed: 3 ~ 4 times/s	ON
		D. C. 10V	10 ms max.
		10kΩ < 10kΩ	OFF
		1 mA Oscillo scope	10 ms max.
		Switch Bouncing Test Circuit	

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Light Touch Switch	EVPAAN02Q	4 / 8

5.2 Mechanical characteristics

No.	ITEM	TEST CONDITION	PERFORMANCE
5.2.1	Operation force	Push force Return force Stroke	Push force $5.0 \begin{array}{ccc} + & 1.0 \\ - & 1.0 \end{array} \text{ N}$ Return force 1.0N min
5.2.2	Travel to closure		0.15 ⁺ 0.1 mm
		Stroke ->	- 0.1
5.2.3	Click ratio	Measurement condition:No.5.2.1 Push force(a) (c) Return force(b)	Click ratio 35 % min. (before reflow soldering)
		Stroke \longrightarrow Click ratio = $(a-c)/a \times 100\%$	
5.2.4	Push strength	50 N for 60 sec.	No damage (Electrical and mechanical
5.2.5	Vibration test	1) Amplitude : 1.5 mm 2) Sweep rate : 10-55-10Hz for 1 minute 3) Sweep method : Logarithmic frequency sweep rate 4) Vibration direction : X,Y,Z(3 directions) 5) Time : Each direction 2 hours (Total 6 hours)	No.5.1 and 5.2.1 to 5.2.2 shall be satisfied.
5.2.6	Soldering heat test	Mount the switch on P.W.B by solder paste. 1) Reflow process 2 times. (Refer to section 6.1) 2) Standard conditions after test: 1 hours	Contact resistance $100 \text{ m}\Omega$ max. No.5.1.2 to 5.1.4 and No.5.2.1 to 5.2.2 shall be satisfied.
5.2.7	Solderbility	After spreading flux, the terminal is immersed in solder with following condition. Solder bar : M705/Sn-3.0Ag-0.5Cu (Senju Metal Industry Co.,Ltd.) Flux : CF-110VH-2A (tamura kaken) Soldering temperture : 260±5 Soldering time : 2±0.5 sec.	95% or more of surface area(Excluding ruptured surface)where is immersed in solder shall be covered by new solder.

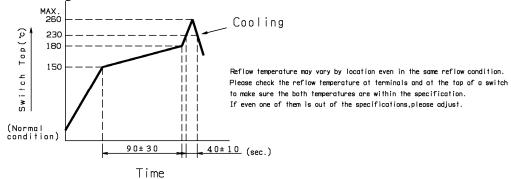
Classification	REFERENCE SPECIFICATION	Issue No. 20151245
Part Name 3.5mm x 2.9mm SMD	Part No.	<i>5</i> / 0
Light Touch Switch	EVPAAN02Q	3 / 8

5.3 Climatic characteristics

No.	ITEM	TEST CONDITION	PERFORMANCE
5.3.1	Cold test	1) Temperature : -40±2	Contact resistance
		2) Duration of test: 1000h	$1000 \text{ m}\Omega$ max.
		3) Take off a drop water.	No.5.1.2 to 5.1.4 and
		4) Standard conditions after test : 1 h	No.5.2.1 to 5.2.2
			shall be satisfied.
5.3.2	Heat test	1) Temperature : 90±2	Contact resistance
		2) Duration of test: 1000h	$1000 \text{ m}\Omega$ max.
		3) Standard conditions after test : 1 h	No.5.1.2 to 5.1.4 and
			No.5.2.1 to 5.2.2
			shall be satisfied.
5.3.3	Heat shock	1) Test cycles : 100 cycles	Contact resistance
	test	2) Standard conditions after test : 1 h	$1000 \text{ m}\Omega \text{ max}.$
		^ A:+90±2	No.5.1.2 to 5.1.4 and
		B:-40±2	No.5.2.1 to 5.2.2
		C:1 hour D:5 minutes max.	shall be satisfied.
		C D E F 1 cycle E:1 hour	
		F:5 minutes max.	
5.3.4	Humidity test	1) Temperature : 60±2	Contact resistance
		2) Relative humidity: 90 ~ 95 %	$1000 \text{ m}\Omega$ max.
		3) Duration of test : 1000 h	No.5.1.2 to 5.1.4 and
		4) Take off a drop water.	No.5.2.1 to 5.2.2
		5) Standard conditions after test : 1 h	shall be satisfied.
5.3.5	Endurance	1) DC 15 V 20 mA Resistance load	Contact resistance
	(Switching	2) Operation speed : 2 ~ 3 times/s	$20~\Omega$ max.
	action)	3) Push force : 10N	Bouncing: 10 ms max.
			Variation rate of
		4) Operation number : 100,000 times	operation force shall
			be within ± 30 % to the
			value before testing
			No.5.1.2 and 5.2.2
			shall be satisfied.
5.3.6	Withstand H ₂ S	1) Density : 3±1ppm	Contact resistance
		2) Temperature : 40±2	$1000 \text{ m}\Omega \text{ max}.$
		3) Relative humidity: 80 ~ 85 %	No.5.1.2 to 5.1.4 and
		4) Duration of test : 24 h	No.5.2.1 to 5.2.2
		5) Standard conditions after test : 1 h	shall be satisfied.

Classification	REFERENCE SPECIFICATION	Issue No. 20151245
Part Name 3.5mm x 2.9mm SMD	Part No.	6 / 0
Light Touch Switch	EVPAAN02O	0 / 8

- 6. Prohibitions and precaution for handling
- 6.1 Reflow soldering condition



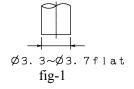
- 1) Two times max. with directing the switch mounting side of P.W.B up.
- 2) Re-soldering by soldering iron shall be allowed under 350 max. 3 sec. max. 1 time only and the tip of iron must not touch to terminals.

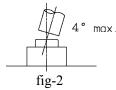
Soldering iron for re-soldering have to be 60 W max.

6.2 Design instructions

- 1) Please refer to the land pattern plan Panasonic recommends on the 2nd page.
- 2) Design key top as fig-1. Design inclination of key top 4 deg. max. as fig-2. Deviation between center of key top and switch should be within 0.3 mm.

(Recommended operation condition)





6.3 Note

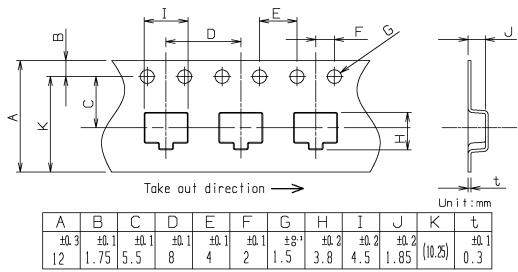
- 1) Please be cautions not to give excessive static load or shock to switches.
- 2) Please be careful not to pile up P.W.B. after switches were soldered.
- 3) Preservation under high temperature and high humidity or corrosive gas should be avoided especially. When you need to preserve for a long period, do not open the carton.
- 4) Avoid pressing the film portion of the product with sharp-edged object.
- 5) Cleaning
 - If flux or solder is scattered on the surface of P.W.B when soldering, characteristics of this product may be damaged.
 - Cleaning after soldering is not allowed. When cleaning is required this switch should be soldered after the cleaning.
- 6) Avoid the use of the switch under pushed ON condition is continued for a long time.
- 7) There is a possibility the flux from solder paste infiltrates into the body if plenty of solder paste was applied by switch on the P.W.B.
 - So we recommend to use our proposed land design in order to prevent above problem.

Also please avoid putting additional land by the switch on the P.W.B.

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Light Touch Switch	EVPAAN02O	/ / 8

7. Packing specification

Carrier tape

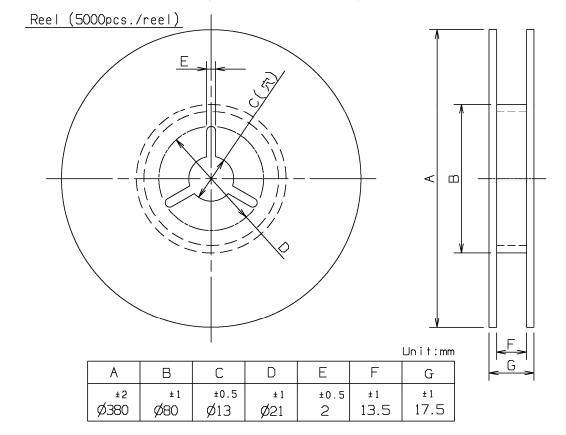


Taping condition: Lack of products in the middle of taping should be one MAX, but total quantity specified in the specifications

should be secured.

Peeling off strength of top tape: It should be within 0.2N to 1.0N at 165 degree in peeling off angle.

Joint of carrier tape : One joint per one reel may exist.



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Part Name 3.5mm x 2.9mm SMD	Part No.	0 / 0
Light Touch Switch	EVPAAN02Q	8 / 8

<Prohibitions and precaution for handling>

[Prohibited items on fire and smoking]

- · Absolutely avoid use of a product beyond its rated range because doing so may cause a fire. If misuse or abnormal use may result under conditions in which the product is used out of its rated range, take proper measures such as current interruption using a protective circuit.
- The grade of nonflammability for resin used in product is "94HB," which is based on UL94 Standards (flammability test for plastic materials). Prohibit use in a location where a spreading fire may be generated or prepare against a spreading fire.

For use in equipment for which safety is requested

- · Although care is taken to ensure product quality, inferior characteristics, short circuits, and open circuits are some problems that might be generated. To design an equipment which places maximum emphasis on safety, review the effect of any single fault of a product in advance and perform virtually fail-safe design to ensure maximum safety by:
 - · Preparing a protective circuit or a protective device to improve system safety, and equipment.
 - · Preparing a redundant circuit to improve system safety so that the single fault of a product does not cause a dangerous situation.

[Attentions required for storage condition]

- When this product is to be stored in the following circumstances and conditions, it may affect on the performance deteriorations and solderability etc., avoid storing in the following conditions.
 - (1) A place where the temperature is -10 max., +40 min. and the humidity is 85% min.
 - (2) In the corrosive gas atmosphere.
 - (3) Long-term storage for 6 months min.
 - (4) A place where the product is exposed to direct sunlight.
- · Store in packed condition so that the load stress is not applied.
- Please use this product as soon as possible, our recommendation is within 3 months and the limitation is 6 months.
- · If any remainder left after packing is opened, store it with proper moisture proofing and gasproofing, etc.,